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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hideji TAJIMA	05/13/2010
Osamu SEGAWA	05/13/2010
Masanari TSUJIMURA	05/20/2010

RECEIVING PARTY DATA

Name:	UNIVERSAL BIO RESEARCH CO., LTD	
Street Address:	88 Kamihongou	
City:	Matsudo-shi, Chiba	
State/Country:	JAPAN	
Postal Code:	271-0064	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number: 12665430	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	10287.120
NAME OF SUBMITTER:	Alan N. Herda

Total Attachments: 3

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PATENT REEL: 024466 FRAME: 0171 12665430

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PATENT REEL: 024466 FRAME: 0172

Assignment - PATENT DOCKET NUMBER: 10287.120

ASSIGNMENT

WHEREAS, WE, Hideji TAJIMA, Osamu SEGAWA, and Masanari TSUJIMURA, of Chiba, Japan, have invented a design or certain improvements in:

COLUMN TIP PROCESSING DEVICE AND COLUMN TIP PROCESING METHOD

for which we have executed the following application for Letters Patent of the United States of America:

U.S. Application No. 12/665,430, filed on December 18, 2009

WHEREAS, UNIVERSAL BIO RESEARCH CO., LTD. (Assignee), a Japanese corporation, having its principal office and place of business at 88, Kamihongou, Matsudo-shi, Chiba 271-0064 Japan, is desirous of obtaining the entire right, title and interest in, to and under said invention and said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto said UNIVERSAL BIO RESEARCH CO., LTD., its successors, legal representatives and assigns, the entire right, title and interest in, to and under said invention, and said application, and all divisionals, renewals, substitutionals and continuing applications thereof, and all Letters Patents of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patents which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner for Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to said UNIVERSAL BIO RESEARCH CO., LTD., its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said UNIVERSAL BIO RESEARCH CO., LTD., its successors, legal representatives and assigns, any facts known to us respecting said inventions, and testify in any legal proceedings, sign all lawful papers, execute all divisionals, renewals, substitutionals, continuing applications and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid said UNIVERSAL BIO RESEARCH CO., LTD., its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said inventions in all countries.

[SIGNATURE PAGE FOLLOWS]

Page 1 of 2

PATENT REEL: 024466 FRAME: 0173

Inventor: Hideji TAJIMA	Date: May. 13, 20/0
Witness:	Date: May 13, 2010
Inventor: Samu Segawa Osamu SEGAWA	Date:
Witness: WishimurA	Date: <u>May (3 2010</u>
Inventor:	Date:
Witness:	Date:

Assignment - PATENT DOCKET NUMBER: 10287,120

Inventor: Daniero Hideji TAJIMA	Date: May. 13, 20/0
Witness: Wichi Mishfunga	Date: May 13. 2010
•	· · · · - · .
Inventor:Osamu SEGAWA	Date:
Witness:	Date:
inventor: Masanari TSUJIMURA	Date: May 20, 20/0
Witness: Tetsusi Mishimues	Date: May 20, 20/0

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Page 2 of 2

PATENT REEL: 024466 FRAME: 0175